



AU OPTRONICS CORPORATION

(V) Preliminary Specifications() Final Specifications

Module	14.0"(13.98") HD ⁺ 16:9 Color TFT-LCD with LED Backlight design	
Model Name	B140RTN03.0 (H/W:3A)	
Note (<table-cell-rows>)</table-cell-rows>	LED Backlight with driving circuit design	

Customer	Date
	<u>/2012</u>
Checked & Approved by	Date
Note: This Specification is without notice.	subject to change

Approved by	Date			
Jonken Fan	10/22/2012			
Prepared by	Date			
Queena Lee	10/22/2012			
NBBU Marketing Division AU Optronics corporation				

B140RTN03.0 Document Version : 0.1





AU OPTRONICS CORPORATION

Contents

1. Handling Precautions	4
2. General Description	5
2.1 General Specification	
2.2 Optical Characteristics	6
3. Functional Block Diagram	
4. Absolute Maximum Ratings	12
4.1 Absolute Ratings of TFT LCD Module	12
4.2 Absolute Ratings of Environment	12
5. Electrical Characteristics	
5.1 TFT LCD Module	13
5.2 Backlight Unit	16
6. Signal Interface Characteristic	17
6.1 Pixel Format Image	17
6.2 Integration Interface Requirement	18
6.3 Interface Timing	21
6.4 Power ON/OFF Sequence	22
7. Panel Reliability Test	
7.1 Vibration Test	25
7.2 Shock Test	25
7.3 Reliability Test	25
8. Mechanical Characteristics	26
8.1 LCM Outline Dimension	26
9. Shipping and Package	28
9.1 Shipping Label Format	28
9.2 Carton Package	
9.3 Shipping Package of Palletizing Sequence	29
10. Appendix: EDID Description	30





Record of Revision

Ver	Version and Date Page		Old description	New Description	Remark
0.1	2012/10/22	All	First Edition for Customer		
					>

Page 3 of 32



AU OPTRONICS CORPORATION

1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.







AU OPTRONICS CORPORATION

2. General Description

B140RTN03.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD⁺, 1600(H) x 900(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP(Embedded DisplayPort) interface compatible.

B140RTN03.0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

Items	Unit		Specifi	cations			
Screen Diagonal	[mm]	355.22					
Active Area	[mm]	309.6 x 174	.15				
Pixels H x V		1600 x 3 (R	GB) x 900				
Pixel Pitch	[mm]	0.1935 x 0.1935					
Pixel Format		R.G.B. Vertical Stripe					
Display Mode		Normally White					
White Luminance	[cd/m ²]	250 typ. (5 points average) 212 min. (5 points average)					
Luminance Uniformity		1.25 max. (5 points)					
Contrast Ratio		400 typ					
Response Time	[ms]	8 typ / 16 Max					
Nominal Input Voltage VDD	[Volt]	+3.3 typ.					
Power Consumption	[Watt]	4.2 max (In	clude Logic	and BL pow	er)		
Weight	[Grams]	270 max.					
Physical Size	[mm]		Min.	Тур.	Max.		
Include bracket		Length	319.9	320.4	320.9		
		Width	204.6	205.1	205.6		
		Thickness	-	-	3.0		
Electrical Interface		1 Lane eDF)				
Glass Thickness	[mm]	0.4					
Surface Treatment		Anti-Glare, Hardness 3H,					
Support Color		262K colors	(RGB 6-bi	t)			

3140RTN03.0 Document Version : 0.1





AU OPTRONICS CORPORATION

Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

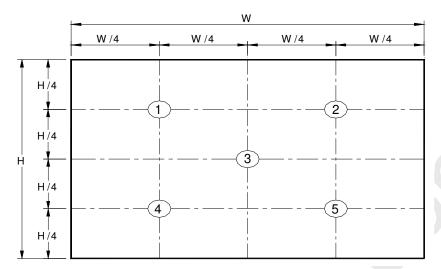
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Lumir	nance		5 points average	212	250	-	cd/m ²	1, 4, 5.
Viewing Angle		θ_{R}	Horizontal (Right)	40	45			
		θ_{L}	CR = 10 (Left)	40	45	-		Ì
viewing Ai	igie	Ψн	Vertical (Upper)	10	15	-	degree	4, 9
		Ψ∟	CR = 10 (Lower)	30	35	-		
Luminance Uniformity		δ_{5P}	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ _{13P}	13 Points	_	-	1.60		2, 3, 4
Contrast Ratio		CR		300	400	-		4, 6
Cross talk		%		-	-	4		4, 7
Response Time		T _{RT}	Rising + Falling	-	8	16	msec	4, 8
Red		Rx			TBD			
		Ry			TBD			
		Gx			TBD			
Color / Chromaticity Coodinates Blue Whit	Green	Gy			TBD			
	(Вх	CIE 1931		TBD			4
	Blue	Ву			TBD		-	
		Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	45	_		



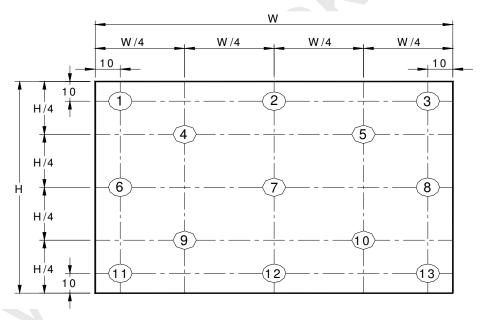


AU OPTRONICS CORPORATION

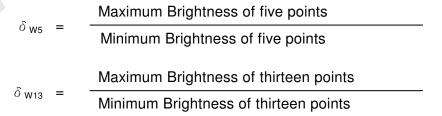
Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance



Note 4: Measurement method

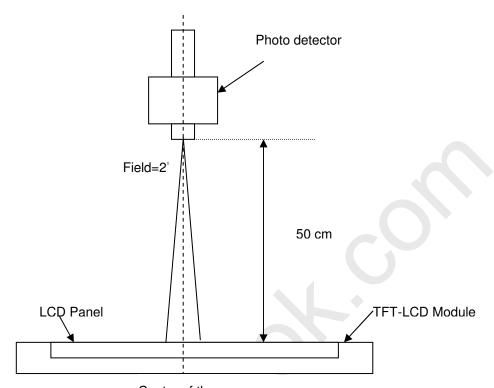
The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting





AU OPTRONICS CORPORATION

Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Center of the screen

Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L(x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Contrast ratio (CR)=
$$\frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

 $Y_A =$ Luminance of measured location without gray level 0 pattern (cd/m₂)

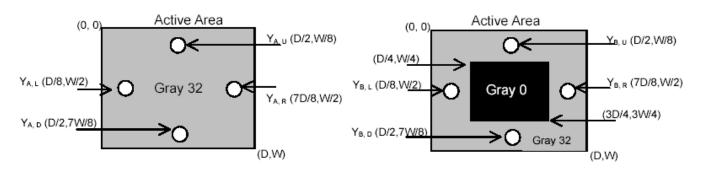
Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)



Global LCD Panel Exchange Center

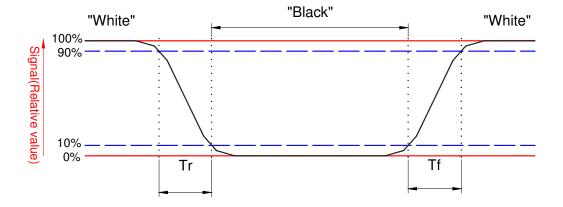
Product Specification

AU OPTRONICS CORPORATION



Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

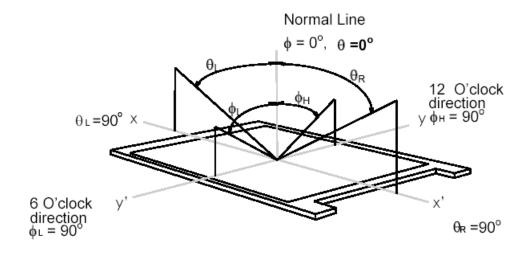




AU OPTRONICS CORPORATION

Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



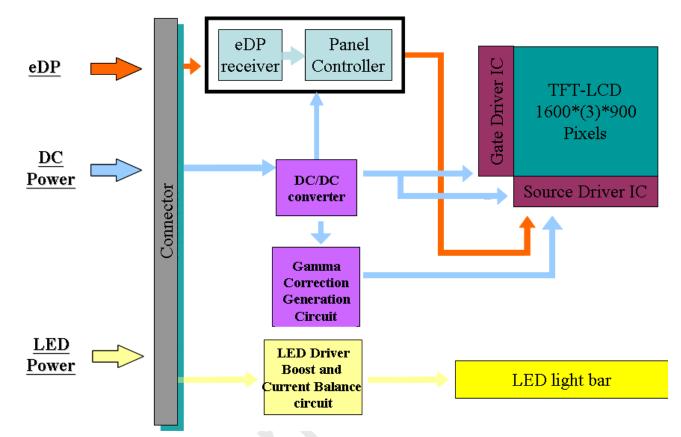




AU OPTRONICS CORPORATION

3. Functional Block Diagram

The following diagram shows the functional block of the 14.0 inches wide Color TFT/LCD 30 Pin







AU OPTRONICS CORPORATION

4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item Symbol		Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

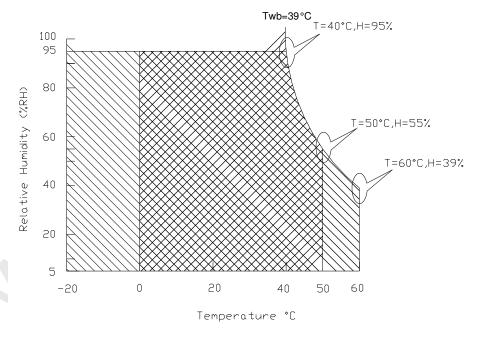
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

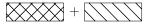
Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range







Global LCD Panel Exchange Center

Product Specification

AU OPTRONICS CORPORATION

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

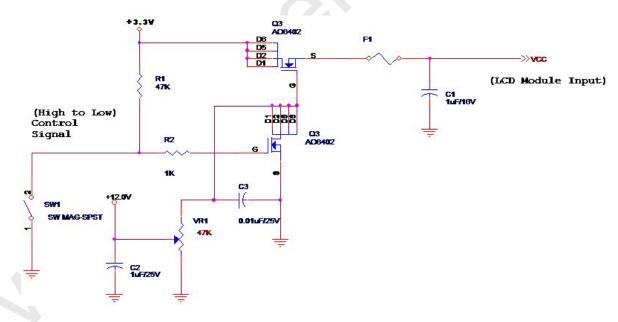
The power specification are measured under 25° C and frame frenquency under 60Hz

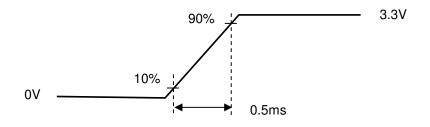
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power		1.1	1.25	[Watt]	Note 1
IDD	IDD Current		300	417	[mA]	Note 1
IRush	Inrush Current		-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage			100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (Pmax=V3.3 x Iblack)

Typical Measurement Condition: Mosaic Pattern

Note 2: Measure Condition









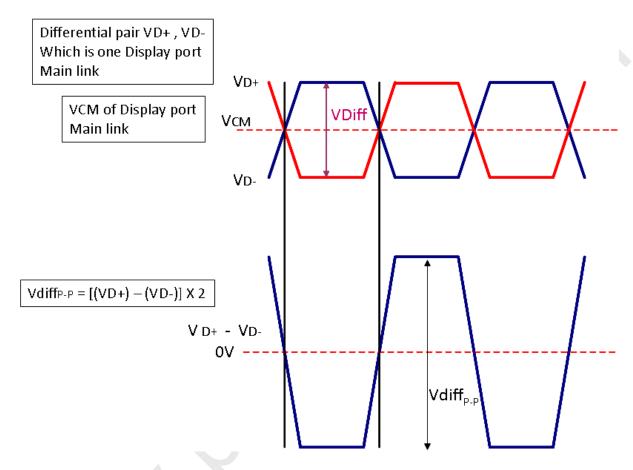
AU OPTRONICS CORPORATION

5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Display Port main link signal:



Display port main link							
		Min	Тур	Max	unit		
VCM	RX input DC Common Mode Voltage	0.668	0.68	0.685	V		
VDiff _{P-P}	Peak-to-peak Voltage at a receiving Device				mV		

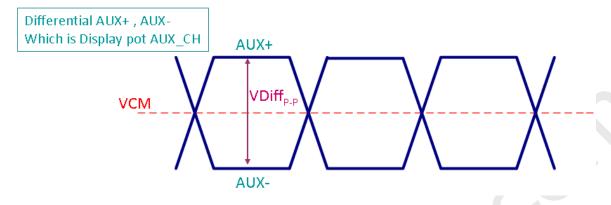
Fallow as VESA display port standard V1.1a





AU OPTRONICS CORPORATION

Display Port AUX_CH signal:



	Display port AUX_CH						
		Min	Тур	Max	unit		
VCM	Differential Common Mode Voltage	0	VDD/2	2	V		
$VDiff_{P-P}$	Differential peak-to-peak Voltage	0.39		1.38	V		

Fallow as VESA display port standard V1.1a.

Display Port VHPD signal:

	Display port VHPD				
		Mir	т Тур	Max	unit
VHPD	HPD Voltage	2.2	5 -	3.6	V

Fallow as VESA display port standard V1.1a.



Global LCD Panel Exchange Center

Product Specification AU OPTRONICS CORPORATION

5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED			2.9	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	15000			Hour	(Ta=25°C), Note 2 I _F =21 mA

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED			7	[Volt]	
LED Enable Input High Level	VLED EN				[Volt]	
LED Enable Input Low Level	VLED_EN				[Volt]	Define as
PWM Logic Input High Level					[Volt]	Connector Interface
PWM Logic Input Low Level	VPWM_EN				[Volt]	(Ta=25℃)
PWM Input Frequency	FPWM	200	1K	10K	Hz	
PWM Duty Ratio	Duty				%	

Note 1 : Recommend system pull up/down resistor no bigger than 10kohm





AU OPTRONICS CORPORATION

6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1						16	00)
1st Line	R G B	R G	В	 R	G	В	R	G	В
900th Line	R G B	R G	В	 R	G	В	R	G	В





6.2 Integration Interface Requirement

6.2.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	I-PEX 20455-030E-12
Mating Housing/Part Number	I-PEX 20453-030T-11 or compatible





6.2.2 Pin Assignment (1 Lane)

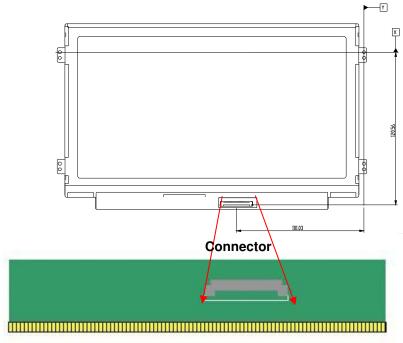
eDP lane is a differential signal technology for LCD interface and high speed data transfer device

PDP lane is	a differential signal ted	chnology for LCD interface and high speed data transfer device.
PIN NO	Symbol	Function
1	NC	No Connect
2	H_GND	High Speed Ground
3	NC	
4	NC	
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	NC	Reverse for AUO TEST only
15	LCD_GND	LCD logic and driver ground
16	LCD_GND	LCD logic and driver ground
17	HPD	HPD signale pin
18	BL_GND	Backlight ground
19	BL_GND	Backlight ground
20	BL_GND	Backlight ground
21	BL_GND	Backlight ground
22	BL_Enable	Backlight On / Off
23	BL_PWM_DIM	System PWM signal Input
24	NC	Reverse for AUO TEST only
25	NC	Reverse for AUO TEST only
26	BL_PWR	Backlight power (6V~21V)
27	BL_PWR	Backlight power (6V~21V)
28	BL_PWR	Backlight power (6V~21V)
29	BL_PWR	Backlight power (6V~21V)
30	NC	No Connect





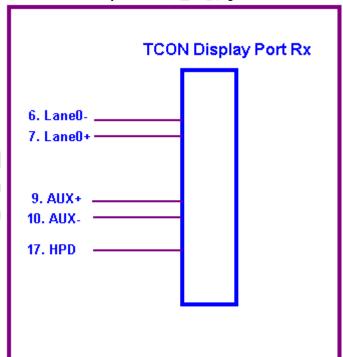
AU OPTRONICS CORPORATION





Note1: Start from right side.

Note2: Input signals shall be low or High-impedance state when VDD is off. Internal circuit of eDP inputs are as following.







AU OPTRONICS CORPORATION

6.3 Interface Timing

6.3.1 Timing Characteristics

Basically, interface timings should match the 1600x900 /60Hz manufacturing guide line timing.

						1
Parai	meter	Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-		60		Hz
Clock fr	equency	1/ T _{Clock}		56.3		MHz
	Period	T _V	908	930	900+A	
Vertical	Active	T _{VD}		900		T _{Line}
Section	Blanking	T _{VB}	8	30	Α	
	Period	T _H	830	1016	800+B	
Horizontal	Active	T _{HD}		800		T _{Clock}
Section	Blanking	Тнв	30	216	В	

Note 1 : The above is as optimized setting

Note 2 : The maximum clock frequency = (800+B)*(900+A)*60<80MHz



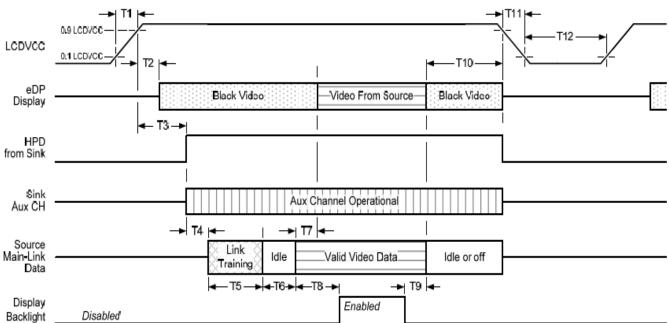
Global LCD Panel Exchange Center

Product Specification

AU OPTRONICS CORPORATION

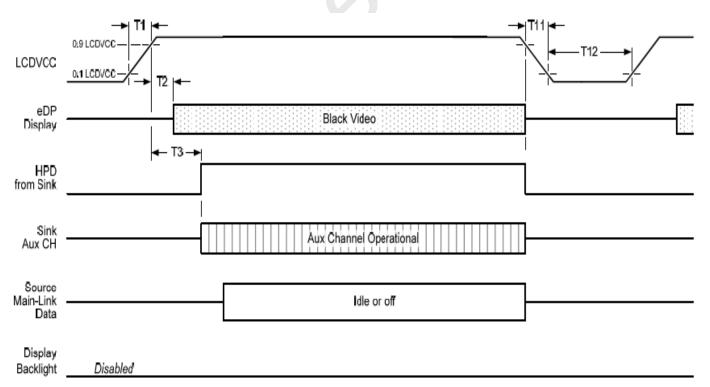
6.4 Power ON/OFF Sequence

Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX_CH transaction only:



Display port interface power up/down sequence, AUX CH transaction only





AU OPTRONICS CORPORATION

Display Port panel power sequence timing parameter:

Timing	Description	Devel Ive	Limits			Notes
parameter	Description	Reqd. by	Min.	Тур.	Max.	Notes
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
Т2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
Т3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
Т5	link training duration	source				dependant on source link to read training protocol.
Т6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
17	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
Т8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
Т9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 905 to 10%	source			10ms	
T12	power off time	source	500ms			

Note1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.

B140RTN03.0 Document Version: 0.1

⁻upon LCDVDD power on (with in T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).

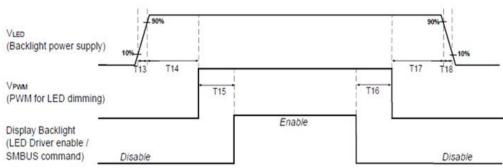
⁻when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.



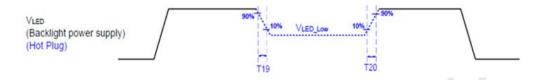
Global LCD Panel Exchange Center

Product Specification AU OPTRONICS CORPORATION

Display Port panel B/L power sequence timing parameter:



Note: When the adapter is hot plugged, the backlight power supply sequence is shown as below.



	Min (ms)	Max (ms)
T13	0.5	10
T14	10	
T15	10	2
T16	10	=
T17	10	4
T18	0.5	10
T19	1*	=
T20	1*	

Seamless change: T19/T20 = 5xT_{PWM}*

*T_{PWM}= 1/PWM Frequency





AU OPTRONICS CORPORATION

7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

• Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
E9D	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. Self-recoverable.

No data lost, No hardware failures.

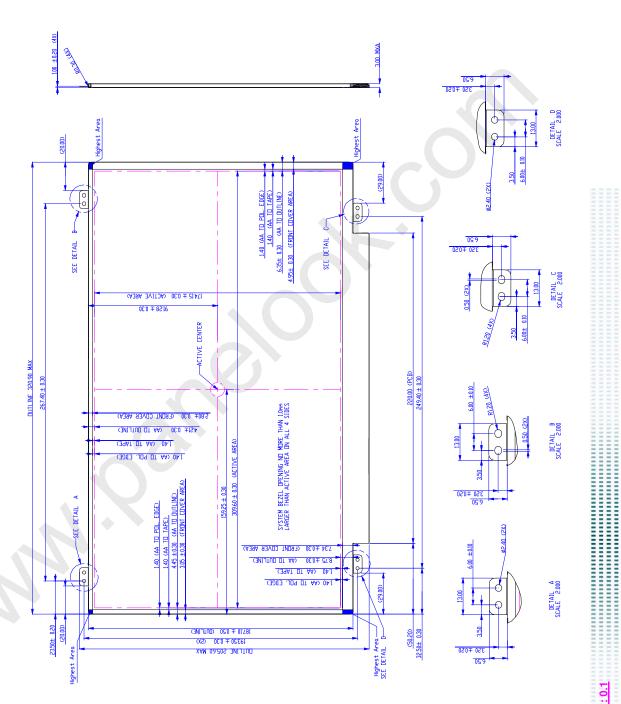
 $\textbf{Remark:} \ \mathsf{MTBF} \ (\mathsf{Excluding} \ \mathsf{the} \ \mathsf{LED}) \\ : 30,000 \ \mathsf{hours} \ \mathsf{with} \ \mathsf{a} \ \mathsf{confidence} \ \mathsf{level} \ 90\% \\$

(P)

Product Specification

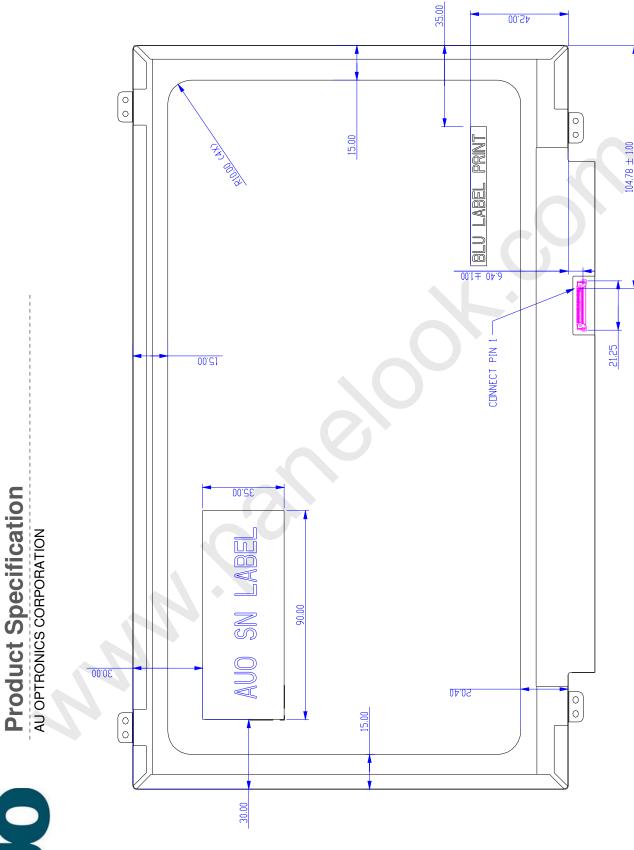
AU OPTRONICS CORPORATION

8. Mechanical Characteristics 8.1 LCM Outline Dimension



45.00

(P)



Note: Prevention IC damage, IC positions not allowed any overlap over these areas.







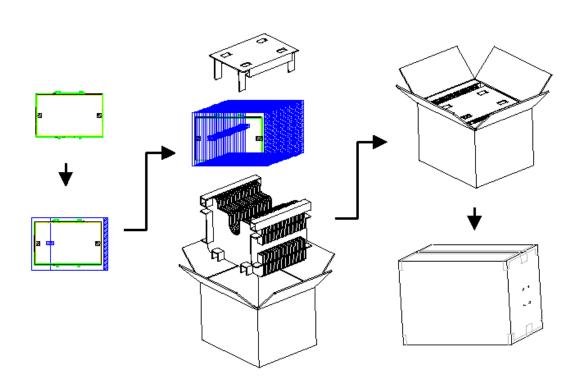
- 9. Shipping and Package
- 9.1 Shipping Label Format

TBD

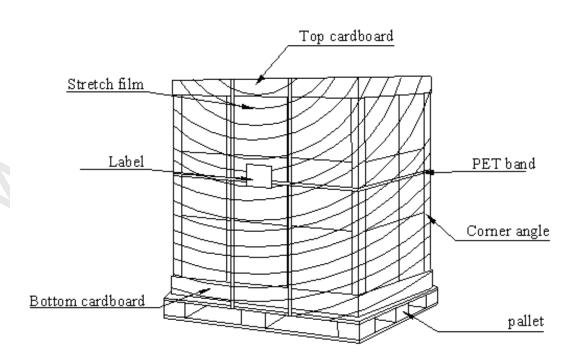








9.3 Shipping Package of Palletizing Sequence







10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	3E	00111110	62	
0B	hex, LSB first	30	00110000	48	
0C	32-bit ser #	00	00000000	• 0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	16	00010110	22	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	95	10010101	149	
15	Max H image size (rounded to cm)	1F	00011111	31	
16	Max V image size (rounded to cm)	11	00010001	17	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	A0	10100000	160	
1 A	Blue/white low bits (Lower 2:2:2:2 bits)	95	10010101	149	
1B	Red x (Upper 8 bits)	99	10011001	153	
1C	Red y/ highER 8 bits	59	01011001	89	
1D	Green x	52	01010010	82	
1E	Green y	92	10010010	146	
1F	Blue x	26	00100110	38	
20	Blue y	21	00100001	33	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	_
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	







		- 		Ι.	l
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	FC	11111100	252	
37	Pixel Clock/10000 USB	2B	00101011	43	
38	Horz active Lower 8bits	40	01000000	64	
39	Horz blanking Lower 8bits	A0	10100000	160	
3A	HorzAct:HorzBlnk Upper 4:4 bits	61	01100001	97	
3B	Vertical Active Lower 8bits	84	10000100	132	
3C	Vertical Blanking Lower 8bits	1E	00011110	30	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	001110000	48	
3E	HorzSync. Offset	40	01000000	64	
3F	HorzSync.Width	2A	00101010	42	
40	VertSync.Offset : VertSync.Width	33	00110011	51	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	35		53	
43	Vertical Image Size Lower 8bits		00110101		
	Horizontal & Vertical Image Size (upper 4:4 bits)	AE	10101110	174	
44	Horizontal Border (zero for internal LCD)	10	00010000	16	
45	Vertical Border (zero for internal LCD)	00	00000000	0	
46		00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Pixel Clock/10,000 (LSB)	53	01010011	83	
49	Pixel Clock/10,000 (MSB)	1D	00011101	29	40Hz frame rate
4A	Horizontal Addressable Pixels, lower 8 bits	40	01000000	64	
4B	Horizontal Blanking Pixels, lower 8 bits	A0	10100000	160	
4C	H Pixels, upper nibble : H Blanking, upper nibble	61	01100001	97	
4D	Vertical Addressable Lines, lower 8 bits	84	10000100	132	
4E	Vertical Blanking Lines, lower 8 bits	1E	00011110	30	
4F	V lines, upper nibble : V blanking, upper nibble	30	00110000	48	
50	Horizontal Front Porch, lower 8 bits	40	01000000	64	
51	Horizontal Sync Pulse, lower 8 bits	2A	00101010	42	
52	V Front Porch, lower nibble : V Sync Pulse, lower nibble	33	00110011	51	
53	VFP, 2 bits: VSP 2 bits: HFP 2 bits: HFP 2 bits	00	00000000	0	
54	Horizontal Image Size in mm, lower 8 bits	35	00110101	53	
55	Vertical Image Size in mm, lower 8 bits	AE	10101110	174	
56	H Image Size, upper nibble : V Image Size, upper nibble	10	00010000	16	
57	Horizontal Border	00	00000000	0	
58	Vertical Border	00	00000000	0	
59	Bit Encode Sync Information	18	00011000	24	
					l de la companya de

Page 31 of 32





5A	DC	00	00000000	0	
5B	HTOTAL	00	00000000	0	
5C	на	00	00000000	0	
5D	HBL	00	00000000	0	
5E	HFP	00	00000000	0	
5F	HFPe	00	00000000	0	
60	НВР	00	00000000	0	
61	НВ	00	00000000	0	
62	HSO	00	00000000	0	nVDPS
63	HS	00	00000000	0	Reserved 00
64	VTOTAL	00	00000000	0	
65	VA	00	00000000	0	
66	VBL	00	00000000	0	
67	VFP	00	00000000	0	
68	VBP	00	00000000	0	
69	VB	00	00000000	0	
6A	VSO	00	00000000	0	
6B	vs	00	00000000	0	
6C	Detail Timing Description #4	00	00000000	0	
6D	Flag	00	00000000	0	
6E	Reserved	00	00000000	0	
6F	For Brightness Table and Power Consumption	02	00000010	2	
70	Flag	00	00000000	0	Header
71	PWM % [7:0] @ Step 0	0C	00001100	12	
72	PWM % [7:0] @ Step 5	3D	00111101	61	
73	PWM % [7:0] @ Step 10	FF	11111111	255	
74	Nits [7:0] @ Step 0	0A	00001010	10	
75	Nits [7:0] @ Step 5	3C	00111100	60	
76	Nits [7:0] @ Step 10	7D	01111101	125	Brightness Table
77	Panel Electronics Power @ 32x32 Chess Pattern =	1B	00011011	27	
78	Backlight Power @ 60 nits =	11	00010001	17	
79	Backlight Power @ Step 10 =	24	00100100	36	
7A	Nits @ 100% PWM Duty =	7D	01111101	125	Power Consumption
7B	Flag	20	00100000	32	
7C	Flag	20	00100000	32	
7D	Flag	20	00100000	32	
7E	Extension Flag	00	00000000	0	
7F	Checksum	3C	00111100	60	